

# J-ICOM

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Organizer:



Rifqi Zidane Amandanu  
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Dear Author,

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ACCEPTANCE LETTER FOR THE JOURNAL INFORMATICS AND COMPUTER TECHNOLOGY (J-ICOM),  
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Thank you for your interest to participate in "The Journal Informatic and Computer Technology" (J-ICOM).  
On behalf of the Organizing Committee, I am delighted to inform you that your paper has been **ACCEPTED**  
and will be proceed to be published in Journal of Informatic and Computer Technology (J-  
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Paper ID : ID 10798.JICOM06-02.186  
Authors : Rifqi Zidane Amandanu, Fajar Astuti Hermawatis  
Title : Uji Tarik Tensile Test Menggunakan Metode Digital Image Corellation (DIC)

We congratulate for your achievement. The technical issues about the publication will be informed later.  
Thank you very much for participating in our journal.

Thank you for your contribution to the Jounal Informatic and Computer Technology (J-ICOM) and we look  
forward to receiving futher submissions from you.

Kind Regards,



Ahmad Ihsan, S.T.,M.T  
Managing Editor, J-ICOM

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